

SURFACE MOUNT FAST SWITCHING DIODE

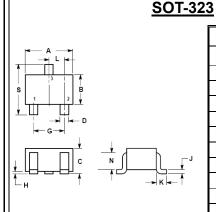
REVERSE VOLTAGE – 75 Volts FORWARD CURRENT – 0.15 Ampere

FEATURES

- · Fast switching speed
- Ideally suited for automatic insertion
- For general purpose switching applications

MECHANICAL DATA

- Case: SOT-323 Plastic
- Case material: "Green" molding compound, UL flammability classification 94V-0, (No Br. Sb. Cl)
- Moisture sensitivity: Level 1 per J-STD-020D
- Lead free in RoHS 2002/95/EC compliant



SOT-323			
Dim.	Min.	Max.	
Α	1.80	2.20	
В	1.15	1.35	
С	0.80	1.00	
D	0.30	0.40	
G	1.20	1.40	
Н	0.00	0.10	
J	0.10	0.25	
K	0.425 Ref.		
L	0.650 Bsc		
N	0.700 Ref.		
S	2.00	2.40	
Dimensions in millimeter			

Maximum Ratings & Thermal Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	BAW56W	Units
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V
Repetitive Peak Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} V_{RRM} \ V_{RWM} \ V_{R} \end{array}$	75	V
RMS Reverse Voltage	V _{R(RMS)}	53	V
Forward Continuous Current	I _{FM}	300	mA
Average Rectified Output Current	Io	150	mA
Non-Repetitive Peak Forward @t=1us Surge Current @t=1s	I _{FSM}	2 1	А
Power Dissipation	P _D	200	mW
Thermal Resistance Junction to Ambient	R⊕JA	625	°C/W
Operating Temperature Range	T _J	150	°C
Storage Temperature Range	T _{STG}	-65~+150	$^{\circ}$ C

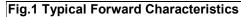
Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Test Condition	Symbol	Min.	Тур.	Max.	Unit
Reverse Breakdown Voltage	I _R = 2.5uA	V_{BR}	75			V
Maximum Forward Voltage	$I_F = 1mA$ $I_F = 10mA$ $I_F = 50mA$ $I_F = 150mA$	V _F	 	 	715 855 1000 1250	mV
Maximum DC Reverse Current at Rated DC Blocking Voltage	$V_R = 75V$ $V_R = 20V$	I _R			2.5 0.025	uA
Typical Diode Capacitance	V _R =0V,f=1MHz	C _D			2	pF
Reverse Recovery time	Irr=1mA, $I_R=I_F=10mA$ $R_L=100\Omega$	trr			4	ns

REV. 2, Jan-2013, KSYR49

RATING AND CHARACTERISTIC CURVES BAW56W





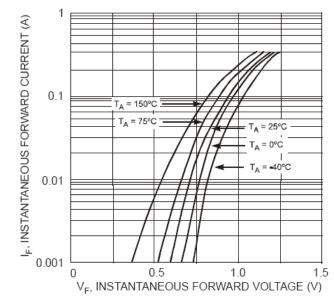


Fig.3 Total Capacitance vs. Reverse Voltage

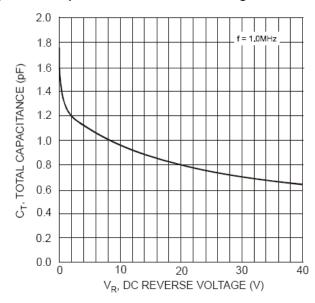


Fig.5 Power Derating Curve

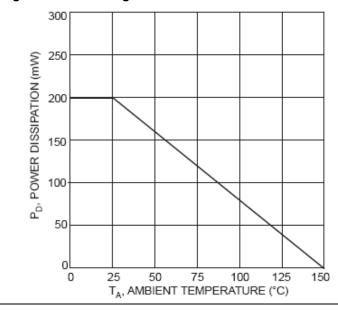


Fig.2 Typical Reverse Characteristics

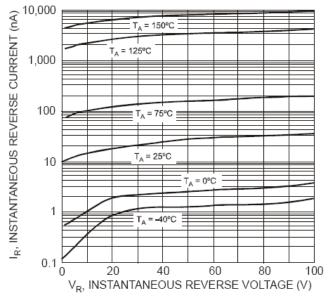
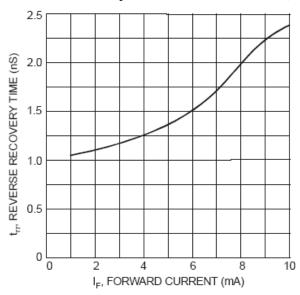


Fig.4 Reverse Recovery Time vs. Forward Current,



Device Marking:

Device P/N	Marking code	Equivalent Circuit Diagram
BAW56W	A1	3 0 0 1



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New Marking Rule Notification

Range: In order to have well management in process control, the new marking rule is applied to small signal device including Switching Diode, Transistor and Schottky Diode.

Package: SOT-23 / SOT-323 / SOT-523

